

Comment	Description CAP, CERM, 10uF, 25V, X7R, CAP,	Designator	rootprint	LibRet	Quantity
	25V, X7R, CAP, CERM, 10uF, 25V,				
	CERM, 10uF, 25V, X7R, CAP, CERM, 10uF, 25V, X7R, CAP, CERM, 22uF, 16V, X7R				
Used in BOM report	CAP, CERM, 22uF, 16V, X7R	C1, C2, C8, C11	1210	Capacitor	
	xxF, xxV, +/-xx%,				
Used in BOM report	xxOhm ESR, [MountType]	C3, C9	SM_RADIAL_C	Capacitor_Polarize d	
	CAP, [Technology], xxxF, xxV, +/-xx%,				
EKXG451ELL680M MN3S	(MountType)	C4	CAPPR7.5-18x31.5	Capacitor_Polarize d	
B32922C3154K	630V, +/-10%, TH	C5, C6	B32922_12mm	B32922C3154K	
Used in BOM report	500V, RES, xxx ohm,				
	x%, xW, (PackageReferenc				
	e), RES, xxx ohm, x%, xW,				
	(PackageReference), RES, xxx ohm,				
	x%, xW, (PackageReferenc	C7. R4. R6. R7	1206	Capacitor, Resistor,	
used in BOM report	e] CAP,[Technology], xxxF,xxV,+/-xx%,	C7, R4, R6, R7	1206	Resistor, Resistor	
25ZL660M X20	xxOhm ESR,	C10	CAPPR5-10x20	Capacitor_Polarize	
25.ZL660M X20	[MountType]	C10	CAPPRS-10x20	d	
EEE-FC1E220P	CAP, AL, 22uF, 25V, +/-20%, 1 ohm, SMD	C12	SM_RADIAL_D	EEE-FC1E220P	
	CAP, CERM, xxxF, 50V, X7R, xx%, [Package Reference], CAP, CERM, xxxF, 50V, X7R, xx%, [Package Reference], CAP, CERM, xxxF, 50V, X7R, xx%,				
	Package Reference]. CAP, CERM, xxxF, xxV, [TempCo], xx%, [Package Reference], RES, xxx ohm, xx, xW, [Package Reference]				
	e], RES, xxx ohm, x%, xW, [PackageReferenc e], RES, xxx ohm				
	x%, xW, [PackageReference], RES, xxx ohm,			Capacitor, Capacitor, Capacitor,	
	e), RES, xxx ohm, x%, xW, [PackageReferenc	C13, C15, C16, C17,		Capacitor, Capacitor, Resistor, Resistor, Resistor,	
Used in BOM report	e)	R1, R5, R8, R101	0805	Resistor, Resistor, Resistor	
	xxv.,[lempCo], xx%, [PackageReference], RES, xxx ohm,				
	e), RES, xxx ohm, x%, xW, [PackageReferenc				
	[PackageReference], RES, xxx ohm, x%, xW.				
	(PackageReference). RES, xxx ohm.				
	x%, xW, [PackageReferenc				
	e], RES, xxx ohm,				
	[PackageReference] el. RES. xxx ohm.				
	x%,xW, [PackageReferenc				
	e), RES, xxx ohm, x%, xW,				
	[PackageReference], RES, xxx ohm,				
	x%,xW, (PackageReferenc				
	e], RES, xxx ohm, x%, xW,			Capacitor, Resistor,	
	(PackageReference), RES, xxx ohm,			Resistor, Resistor, Resistor, Resistor,	
	x%,xW, [PackageReferenc	C14, R9, R10, R11,		Resistor, Resistor,	
Used in BOM renort	[PackageReference], RES, xxx ohm, x%, xW,	R12, R13, R14, R15, R16, R17, R18, R19,	0803	Resistor, Resistor, Resistor, Resistor, Resistor, Resistor, Resistor, Resistor,	
Used in BOM report	[Package Reference], RES, xxx ohm, x%, xW, [Package Reference]	R12, R13, R14, R15,	0603	Resistor, Resistor, Resistor, Resistor, Resistor, Resistor, Resistor	
	[PackageReference], RES, xxx ohm, x%, xW, [PackageReferencolous, xxw, xxv, xxA, [PackageReferenc	R12, R13, R14, R15, R16, R17, R18, R19, R20, R21, R22		Resistor, Resistor, Resistor	
	[Package Reference], RES, xxx ohm, x%, xW, [Package Referenconder, scholary, xxV, xxA, [Package Reference]	R12, R13, R14, R15, R16, R17, R18, R19,	0603 SMA	Resistor, Resistor,	
	[Package Reference], RES, xxx ohm, x%, xW, [Package Referencollag, scholag, xxV, xxA, [Package Reference]] Diode, Zener, 18V, 225mW, SOT-23,	R12, R13, R14, R15, R16, R17, R18, R19, R20, R21, R22		Resistor, Resistor, Resistor	
	[Package Reference], RES, xxx ohm, xX, xW, [Package Reference Unions, consister, xxV, xxA, [Package Reference]] Diode, Zener, 18V, 225mW, SOT-23, Diode, Zener, 18V, 225mW, SOT-23,	R12, R13, R14, R15, R16, R17, R18, R19, R20, R21, R22		Resistor, Resistor, Resistor Diode_Schottky	
8TPS1150A 8ZX84C20LT1G	[Package Reference], RES, xxx ohm, x%, xW, Package Reference Unione, schooling, xxV, xxA, [Package Reference] Diode, Zener, 18V, 225mW, SOT-23, Diode, Zener, 18V, 225mW, SOT-23, Diode, Zener, 18V, 225mW, SOT-23, Diode, Zener, 20V, 225mW, SOT-23, Diode, Zener, 20V, 225mW, SOT-23 Diode, Zener, 20V, 25mW, SOT-23 Diode, Switching- Bridge,	R12, R13, R14, R15, R16, R17, R18, R19, R20, R21, R22 D1, D4	SMA SOT-23	Resistor, Resistor, Resistor  Diode_Schottky  MMBZ5248BLT1G, MMBZ5248BLT1G, BZX84C20LT1G	
8TPS1150A 8ZX84C20LT1G	Package Reference, RES, xxx ohm, xtx, xw., xxx ohm, xtx, xw. xxx ohm, xxx, xxx ohm, xxx, xxx ohm, xxx, xxx ohm, xxx, xxx ohm, xxx	R12, R13, R14, R15, R16, R17, R18, R19, R20, R21, R22	SMA	Resistor, Resistor, Resistor  Diode_Schottky  MMBZ5248BLT1G, MMBZ5248BLT1G,	
BZX84C20LT10 DF06S-E3	(Package Reference), RES, xxx Me, RES, xxx Me, RS, xxx Me, xxx, xxx, xxx, xxx, xxx, xxx,	R12, R13, R14, R15, R16, R17, R18, R19, R20, R21, R22 D1, D4	SMA SOT-23	Resistor, Resistor, Resistor  Diode_Schottky  MMBZ5248BLT1G, MMBZ5248BLT1G, BZX84C20LT1G	
BZX84C20LT1G DF06S-E3	(Package Reference)  + (RES, xxx OH)  + (X5, XW)  + (X5, XW)  + (X5, XW)  + (Y64)  +	R12, R13, R14, R15, R16, R17, R16, R19, R20, R21, R22 D1, D4	SMA SOT-23 DF-S	Resistor, Resistor, Resistor  Diode_Schottky  MMB25248BLT10, BZX84C20LT10  DF06S-E3	
BZX84C20LT10 DF06S-E3	(Package Reference) + (RES, xxx obs.) RES, xxx obs., xxx, xxx, xxx, xxx, xxx, xxx, xxx, x	R12, R13, R14, R15, R16, R17, R16, R19, R20, R21, R22 D1, D4	SMA SOT-23 DF-S	Resistor, Resistor, Resistor  Diode_Schottky  MMBZ5248BLT10, MMBZ5248BLT10  DF08S-E3  Diode_Schottky	
BZZS4CZOLTIG DF06S-E3 US1J MBRB8H100 D-MMSD914T1	(Package Reference, 187, NO. 1	R12, R13, R14, R15, R16, R17, R16, R19, R20, R21, R22 D1, D4	SMA SOT-23 DF-S	Resistor, Resist	
BZX84C20LT1G DF06S-E3 US1J	Package Reference  1. HES, sex dem  1. H	R12, R13, R14, R15, R16, R17, R16, R17, R16, R17, R16, R17, R16, R17, R16, R19, R20, R21, R22 D1, D4 D2, D5, D10 D3 D6	SMA SOT-23 DF-S SMA DDPAK	Resistor, Resistor, Resistor Diode_Schottky MMBZ5248BLT1G, MMBZ5248BLT1G, BZK44C26LT1G DF06S-E3 Diode_Schottky Diode_Schottky_A3 C4	
BZZS4CZOLTIG DF06S-E3 US1J MBRB8H100 D-MMSD914T1	(Package Reference, 187, 200 - 18	R12, R13, R14, R15, R12, R12, R12, R12, R15, R17, R16, R17, R16, R17, R16, R19, R20, R21, R22 D1, D4 D2, D5, D10 D3 D6	SMA SOT-23 DF-S SMA DDPAK SOD-123	Resistor, Resist	
STPS1150A  BZZE4C20LT1G  DF06S-E3  US1J  MBRBBH100  D-MMSD914T1  WBR0520LT1G  USE_WS_SERIE	Package Research  19 Res you can  Package Research  20 April 20 Ap	R12, R13, R14, R15, R12, R12, R12, R12, R15, R17, R16, R17, R16, R17, R16, R19, R20, R21, R22 D1, D4 D2, D5, D10 D3 D6	SMA  SOT-23  DF-S  SMA  DDPAK  SOD-123  SOD-123  FUSE_170_	Resistor, Resist	
BZZS4CZOLTIG DF06S-E3 US1J MBRB8H100 D-MMSD914T1	Package Release  J. RES. you can  J. RES. you can  Package Release  ON you  A. Package Release  ON you	R12, R13, R14, R15, R12, R12, R12, R12, R15, R17, R16, R17, R16, R17, R16, R19, R20, R21, R22 D1, D4 D2, D5, D10 D3 D6	SMA SOT-23 DF-S SMA DDPAK SOD-123 SOC-123	Resistor, Resistor, Resistor, Resistor, Resistor  Basistor  MMB 25248BLT10, MMB 25248BLT10, BZX84G20LT10  DF068-E3  Diode_Schottky  Diode_Schottky  Diode_Schottky  A3  C4  O-MMSD 214T1  MBR 0520LT10  MBR 0520LT10  MBR 0520LT10	
STPS1150A  BZZE4C20LT1G  DF06S-E3  US1J  MBRBBH100  D-MMSD914T1  WBR0520LT1G  USE_WS_SERIE	Package Research  19 Res you can  Package Research  20 April 20 Ap	R12, R13, R14, R15, R12, R12, R12, R12, R15, R17, R16, R17, R16, R17, R16, R19, R20, R21, R22 D1, D4 D2, D5, D10 D3 D6	SMA  SOT-23  DF-S  SMA  DDPAK  SOD-123  SOD-123  FUSE_170_	Resistor, Resist	
BZESHCZOLTIQ DFOSS-E3 USS1J USS1J USS1J USS2SERIE USS2SERIE UUSS2SERIE UUSS24-401LF	Package Reterne	R12,R13,R14,R15,R16,R15,R16,R15,R16,R15,R16,R15,R16,R15,R16,R15,R16,R15,R15,R25,R21,R22,R21,R21,R22,R21,R21,R22,R21,R21	SMA  DF-S  SMA  DDPAK  SOD-123  SOD-123  FUSE_27D_  ND_UU9.6V	Restator, Restat	
STPS1150A  BEZEACC20LT1G  DF068-E3  US13  US13  MBR BBH100  D-MM SDH14T1  MBR 0200LT1G  UUE_TKS_BERKE  UUUB_W-401LF	Package Reterned, 1985, von den 1985, von de	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	5MA  507-23  DP-5  SMA  D0PAK  500-123  500-123  FUSE_370_  NO_UUSAV  NO_WE-13X23MM	Restator, Restat	
STPS1150A  BEZEACC20LT1G  DF068-E3  US13  US13  MBR BBH100  D-MM SDH14T1  MBR 0200LT1G  UUE_TKS_BERKE  UUUB_W-401LF	Package Reterned, 1985, von den 1985, von de	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	5MA  507-23  DP-5  SMA  D0PAK  500-123  500-123  FUSE_370_  NO_UUSAV  NO_WE-13X23MM	Restator, Restat	
BZZE4C20LT1G  BZZE4C20LT1G  DF068-E3  US1J  WBRBBH100  D-MMBDB14T1  WBR020LT1G  UUS-145, SERIE-  UUS-20-4051LF  74423220	Package Research  1 MS . voc and  Package Research  Package Research  Package Research  Package Research  Package Research  2007 200 200 200 200 200 200 200 200 200	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	SMA  BOT-23  DP-8  SMA  DSPAK  BOD-123  SOD-123  SOD-123  FUSE_270  ND_UUSEV  ND_UUSEV  ND_WE-13323MM	Restator, Restat	
BZZE4C20LT1G  BZZE4C20LT1G  DF068-E3  US1J  WBRBBH100  D-MMBDB14T1  WBR020LT1G  UUS-145, SERIE-  UUS-20-4051LF  74423220	Package Research  19 RS, soo and  10 RS, soo a	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	SMA  BOT-23  DP-8  SMA  DSPAK  BOD-123  SOD-123  SOD-123  FUSE_270  ND_UUSEV  ND_UUSEV  ND_WE-13323MM	Restator, Restat	
STPS1150A  B2284C20LT1G  DF066-E3  US11  U	Package Research  1985 - See day  1986 - See d	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	5MA  507-23  DP-8  SMA  DBPAK  S00-123  S00-123  S00-123  FUSE_370  ND_9US#V  ND_9US#V  S07-23  DPAK  S07-23  S07-23	Restator, Restat	
BZZS4G20LT1G  BZZS4G20LT1G  DF068.E3  US1J  US1J	Package Reterned, 1985. No other 198	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	5MA  507-23  DP-8  5MA  500-123  500-123  500-123  FUSE_170_  NO_UUS 8V  NO_WE-13323MM  DP-8A  507-23  2512	Restator, Restat	
STPS1150A  B2284C20LT1G  DF066-E3  US11  U	Package Research  1 May	R12, R13, R14, R15, R16, R16, R17, R18, R17, R28, R17, R28, R17, R28, R17, R28, R17, R28, R17, R28, R17, R18, R18, R18, R18, R18, R18, R18, R18	5MA  507-23  DP-8  SMA  DBPAK  S00-123  S00-123  S00-123  FUSE_370  ND_9US#V  ND_9US#V  S07-23  DPAK  S07-23  S07-23	Restator, Restat	
BZZSZ4G28LT1G  BZZSZ4G28LT1G  BZZSZ4G28LT1G  BZZSZ4G28LT1G  BZZSZ5G28LT1G  BZZSZ5	Package Research   1985 - 1986 - 19	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	SMA  SOT-23  DP-6  SMA  ODPAK  SOD-123	Restator, Restat	
BTPS1150A  BZX34C20LT1G  DF068-E3  US13  US13  MBRBBH100  D-MMBDH14T1  US12  US13  FR.SP020M60C3  FR.SP020M60C3  US46 in BOM report  Us46 in BOM r	Pickup Research  19 A S., see Jan.  19 A S., see Ja	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	5MA  507-23  5PA  508-23  500-123  500-123  500-123  FUEL 170  FUE	Resistor Resistor, Resistor Re	
BZZSZ4G28LT1G  BZZSZ4G28LT1G  BZZSZ4G28LT1G  BZZSZ4G28LT1G  BZZSZ5G28LT1G  BZZSZ5	Package Research  19 RS, soo almo  19 RS	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	SMA  BOT-23  DP-6  SMA  DDPAK  SOD-123	Restator, Restat	
BZ254C20LT1G  DF065.E3  WBR BBH100  DAMS D914T1  WBR SD914T1  WBR SD914T1  TR SP D03Ne0C3  WBR T300B  Used in BOM report  Used in BOM report  D146 in BOM report	Pickup Research  19 A S., see Jan.  19 A S., see Ja	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	594A  507-23  57-6  594  500-123  500-123  500-123  500-123  700-123  700-124  700-125  700-1	MM22248BLT10, Dode_Schemy  MM22248BLT10, Dode_Schemy  MM22248BLT10, Dode_Schemy  Dode_Schemy  Dode_Schemy  Dode_Schemy  Dode_Schemy  Dode_Schemy  Responses  Dode_Schemy  Responses  Respon	
STPS150A  B2Z84C22LT1Q  DF066.E3  UB1J  UB	Package Research  19 RS, see almost  19 RS, see alm	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	594A  507-23  57-6  594  500-123  500-123  500-123  500-123  700-123  700-123  700-124  700-125  700-1	Restator, Restat	
B778150A  B2284G20LT1G  B2284G20LT1G  B2284G20LT1G  B2384G20LT1G  B388B8H100  D388B8H100	Pickup Research  19 A S., and annual  Pickup Research  Pickup Research  Pickup Research  19 A S., and annual  Pickup Research  19 A S., and annual  19 A S.,	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	5MA  507-23  507-6  5MA  507-8  500-123  500-123  FUBE_370  100_UUB_8V  100_UU	Restator, Restat	
BZZS4C20LT1G  DF060-E3  MBRBBH100  D-MMSD914T1  MBRBBH100  D-MMSD914T1  MBRDS010T1G  TR-SPD03M60C3  MMBT330C8  Used in BOM report  Used in BOM report  PATS2727xxxxx80000  PatNumber  Patronimber  Patro	Package Research   Package Res	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	594A  507-23  57-6  594  500-123  500-123  500-123  500-123  700-123  700-123  700-124  700-125  700-1	Restator, Restat	
B778150A  B2284G20LT1G  B2284G20LT1G  B2284G20LT1G  B2384G20LT1G  B388B8H100  D388B8H100	Pickup Research  19 A S., and annual  Pickup Research  Pickup Research  Pickup Research  19 A S., and annual  Pickup Research  19 A S., and annual  19 A S.,	R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	5MA  507-23  507-6  5MA  507-8  500-123  500-123  FUBE_370  100_UUB_8V  100_UU	Restator, Restat	
BZZS4C20LT1G  DP268-E3  US13  MBRBBH100  D-MMSD91471  MBRD91470  BT2-T47L-T47B-T47  BT2-T47L-T47B-T47  BT3-T47L-T47B-T47  BT3-T	Package Research  1, 200 - 1,	R12, R13, R14, R15, R12, R13, R14, R15, R15, R15, R15, R15, R15, R15, R15	5MA  507-23  DP-5  SMA  DDPAK  500-123  D0-123  D0-123  P0-123  P0-123	Resistor, Resist	

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